【原因、判断要点、发生工序】SR 搅拌或者涂布时卷 人固化的 SR 油墨屑而引起的(SR 搅拌工序)。

[Causes/processes involved/keys to judgment]

The defect is caused by entrapping a solidified solder resist ink debris during solder resist application or solder resist ink mixing (Solder resist ink preparation or solder resist application)



2-2-1-9 人体系異物付着/附着人体的污垢 / Human-originated foreign object

【特徴】剥離皮膚、フケ等が付着している状態の欠 陥

【特征】附着肤皮、头皮等的缺陷。

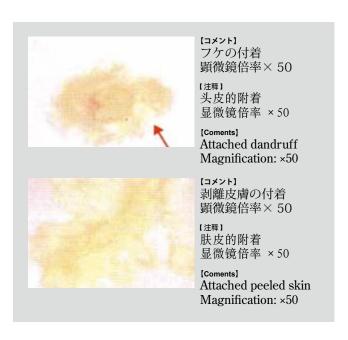
[Characteristics] Peeled skin, dandruff, etc. is attached.

【原因・判断ポイント・発生工程】剥離した皮膚や垢、フケなどが、SR表面や、導体表面に付着して出来たもの(全工程)

【原因、判断要点、发生工序】在 SR 或者导线表面 附着从人体脱落的肤皮、污垢、头皮等所引起的(全过程)。

[Causes/processes involved/keys to judgment]

The defect is caused by the attachment of peeled skin, dirt, dandruff on the surface of solder resist or a conductor (Whole processes)

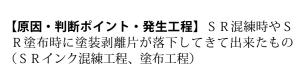


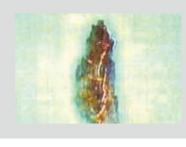
2-2-1-10 SR 剥離塗装片巻込み/ SR 卷入油漆屑/ Peeled paint debris in solder resist

【特徴】SR表面に塗装剥離片が付着している状態の欠陥

【特征】SR 表面附着油漆屑的缺陷。

[Characteristics] Peeled paint debris is attached to the solder resist surface.





顕微鏡倍率× [注釋] 显微镜倍率× [Coments]

Magnification: ×